

TRENCHSTOP™ IGBT6 with soft, fast recovery antiparallel Rapid diode

Features

- $V_{CE} = 650\text{ V}$
- $I_C = 15\text{ A}$
- Very low $V_{CE(sat)}$ 1.5 V (typ.)
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Short circuit withstand time 3 μs
- Very tight parameter distribution
- High ruggedness, temperature stable behavior
- Low $V_{CE(sat)}$ and positive temperature coefficient
- Low gate charge Q_G
- Pb-free lead plating; RoHS compliant
- Very soft, fast recovery antiparallel Rapid diode
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

- General purpose drives (GPD)
- Air conditioning
- Other major home appliances
- Other small home appliances

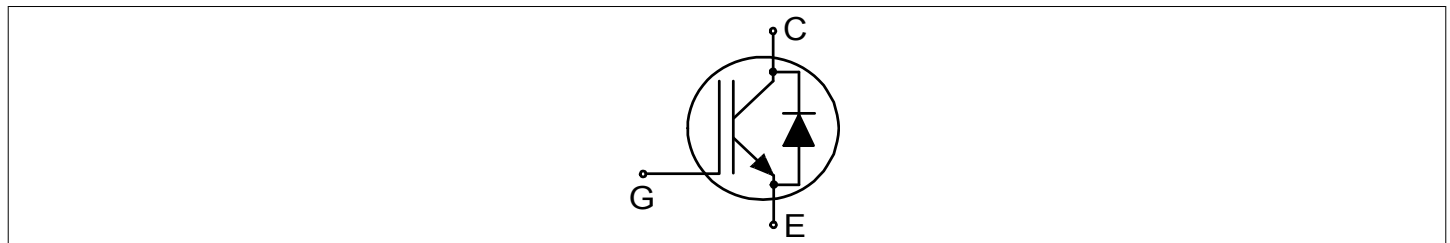
Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description



- Lead-Free
- Green
- Halogen-Free
- RoHS



| Type | Package | Marking |
|-------------|---------------|---------|
| IKA15N65ET6 | PG-TO220-3 FP | K15EET6 |

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1 Package

Table 1 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--|---------------|---|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Isolation test voltage RMS | V_{isol} | $f = +50/+60$ Hz, $t = 1$ min | | | 2500 | V |
| Internal emitter inductance measured 5 mm (0.197 in) from case | L_E | | | 7.0 | | nH |
| Storage temperature | T_{stg} | | -55 | | 150 | °C |
| Soldering temperature | | wave soldering 1.6mm (0.063in.) from case for 10s | | | 260 | °C |
| Mounting torque, M3 screw Maximum of mounting processes: 3 | M | | | | 0.5 | Nm |
| Thermal resistance, junction-ambient | $R_{th(j-a)}$ | | | | 65 | K/W |

2 IGBT

Table 2 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit |
|--|-------------|--|--------|------|
| Collector-emitter voltage | V_{CE} | $T_{vj} \geq 25$ °C | 650 | V |
| DC collector current, limited by T_{vjmax} ¹⁾ | I_C | $T_h = 25$ °C | 34 | A |
| | | $T_h = 100$ °C | 21 | |
| Pulsed collector current, t_p limited by T_{vjmax} | I_{Cpuls} | | 57.5 | A |
| Turn-off safe operating area | | $V_{CE} \leq 650$ V, $T_{vj} \leq 175$ °C | 57.5 | A |
| Gate-emitter voltage | V_{GE} | | ±20 | V |
| Transient gate-emitter voltage | V_{GE} | $t_p \leq 10$ μs, $D < 0.010$ | ±30 | V |
| Short-circuit withstand time | t_{SC} | $V_{CC} \leq 360$ V, $V_{GE} = 15$ V, Allowed number of short circuits < 1000, Time between short circuits ≥ 1.0 s, $T_{vj} = 150$ °C | 3 | μs |
| Power dissipation | P_{tot} | $T_h = 25$ °C | 35.3 | W |
| | | $T_h = 100$ °C | 17.6 | |

1) Limited by maximum junction temperature. Applicable for TO220 standard package.

Table 3 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|---|-------------|--|---|------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Collector-emitter breakdown voltage ¹⁾ | V_{BRCES} | $I_C = 0.1 \text{ mA}, V_{GE} = 0 \text{ V}$ | 650 | | | V |
| Collector-emitter saturation voltage | V_{CEsat} | $I_C = 11.5 \text{ A}, V_{GE} = 15 \text{ V}$ | $T_{vj} = 25 \text{ °C}$ | 1.5 | 1.9 | V |
| | | | $T_{vj} = 125 \text{ °C}$ | 1.65 | | |
| | | | $T_{vj} = 150 \text{ °C}$ | 1.75 | | |
| Gate-emitter threshold voltage | V_{GEth} | $I_C = 0.20 \text{ mA}, V_{CE} = V_{GE}$ | 4.8 | 5.6 | 6.4 | V |
| Zero gate-voltage collector current | I_{CES} | $V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$ | $T_{vj} = 25 \text{ °C}$ | | 30 | μA |
| | | | $T_{vj} = 150 \text{ °C}$ | | 450 | |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$ | | | 100 | nA |
| Transconductance | g_{fs} | $I_C = 11.5 \text{ A}, V_{CE} = 20 \text{ V}, T_{vj} \geq 25 \text{ °C}$ | | 11.6 | | S |
| Short-circuit collector current | I_{SC} | $V_{CC} \leq 360 \text{ V}, V_{GE} = 15 \text{ V}, t_{SC} \leq 3 \mu\text{s}$, Allowed number of short circuits < 1000 , Time between short circuits $\geq 1.0 \text{ s}$, $T_{vj} = 150 \text{ °C}$ | | 120 | | A |
| Input capacitance | C_{ies} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$ | | 1020 | | pF |
| Output capacitance | C_{oes} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$ | | 50 | | pF |
| Reverse transfer capacitance | C_{res} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$ | | 20 | | pF |
| Gate charge | Q_G | $I_C = 11.5 \text{ A}, V_{GE} = 15 \text{ V}$ | | 37 | | nC |
| Turn-on delay time | t_{don} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$ | $T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$ | 30 | | ns |
| | | | $T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$ | 27 | | |
| Rise time (inductive load) | t_r | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$ | $T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$ | 22 | | ns |
| | | | $T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$ | 23 | | |
| Turn-off delay time | t_{doff} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$ | $T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$ | 117 | | ns |
| | | | $T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$ | 135 | | |
| Fall time (inductive load) | t_f | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$ | $T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$ | 42 | | ns |
| | | | $T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$ | 67 | | |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--|------------|--|--|------|------|--------------------|
| | | | Min. | Typ. | Max. | |
| Turn-on energy | E_{on} | $V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$ | $T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.23 | | mJ |
| | | | $T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.32 | | |
| Turn-off energy | E_{off} | $V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$ | $T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.11 | | mJ |
| | | | $T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.18 | | |
| Total switching energy | E_{ts} | $V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$ | $T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.34 | | mJ |
| | | | $T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$ | 0.5 | | |
| IGBT thermal resistance, junction to case | R_{thjc} | | | | 4.3 | K/W |
| IGBT thermal resistance, junction to heat sink | R_{thjh} | | | | 4.30 | K/W |
| Operating junction temperature | T_{vj} | | -40 | | 175 | $^{\circ}\text{C}$ |

1) Measured with filter network.

Note: Electrical Characteristic, at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---|-------------|--|-------------------------------------|------|---|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} \geq 25\text{ }^{\circ}\text{C}$ | 650 | V | |
| Diode forward current, limited by T_{vjmax} ¹⁾ | I_F | | $T_h = 25\text{ }^{\circ}\text{C}$ | 34 | A |
| | | | $T_h = 100\text{ }^{\circ}\text{C}$ | 21 | |
| Diode pulsed current, limited by T_{vjmax} | I_{Fpuls} | | 57.5 | A | |

1) Limited by maximum junction temperature. Applicable for TO220 standard package.

Table 5 Characteristic values

| Parameter | Symbol | Note or test condition | | Values | | | Unit |
|---|--------------|------------------------|---|--------|-------|------|------------------------|
| | | | | Min. | Typ. | Max. | |
| Diode forward voltage | V_F | $I_F = 11.5 \text{ A}$ | $T_{vj} = 25 \text{ °C}$ | | 1.5 | 1.95 | V |
| | | | | | 1.48 | | |
| | | | | | 1.43 | | |
| Reverse leakage current | I_R | $V_R = 650 \text{ V}$ | $T_{vj} = 25 \text{ °C}$ | | | 30 | μA |
| | | | $T_{vj} = 150 \text{ °C}$ | | 450 | | |
| Diode reverse recovery time | t_{rr} | $V_R = 400 \text{ V}$ | $T_{vj} = 25 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 69 | | ns |
| | | | $T_{vj} = 150 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 113 | | |
| Diode reverse recovery charge | Q_{rr} | $V_R = 400 \text{ V}$ | $T_{vj} = 25 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 0.210 | | μC |
| | | | $T_{vj} = 150 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 0.500 | | |
| Diode peak reverse recovery current | I_{rrm} | $V_R = 400 \text{ V}$ | $T_{vj} = 25 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 5.1 | | A |
| | | | $T_{vj} = 150 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | 8.0 | | |
| Diode peak rate of fall of reverse recovery current | di_{rr}/dt | $V_R = 400 \text{ V}$ | $T_{vj} = 25 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | -265 | | $\text{A}/\mu\text{s}$ |
| | | | $T_{vj} = 150 \text{ °C}$, $I_F = 11.5 \text{ A}$, $-di_F/dt = 400 \text{ A}/\mu\text{s}$ | | -228 | | |
| Diode thermal resistance, junction to case | R_{thjc} | | | | | 5.8 | K/W |
| Diode thermal resistance, junction to heat sink | R_{thjh} | | | | | 5.80 | K/W |
| Operating junction temperature | T_{vj} | | | -40 | | 175 | $^{\circ}\text{C}$ |

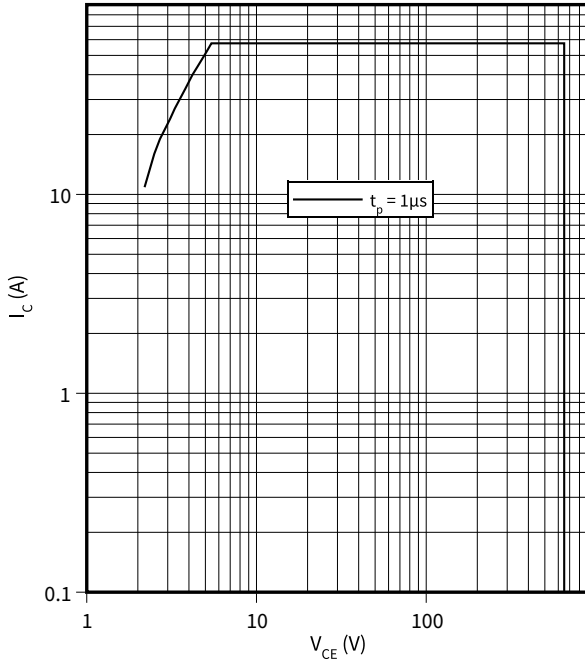
Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

Forward bias safe operating area, IGBT

$$I_C = f(V_{CE})$$

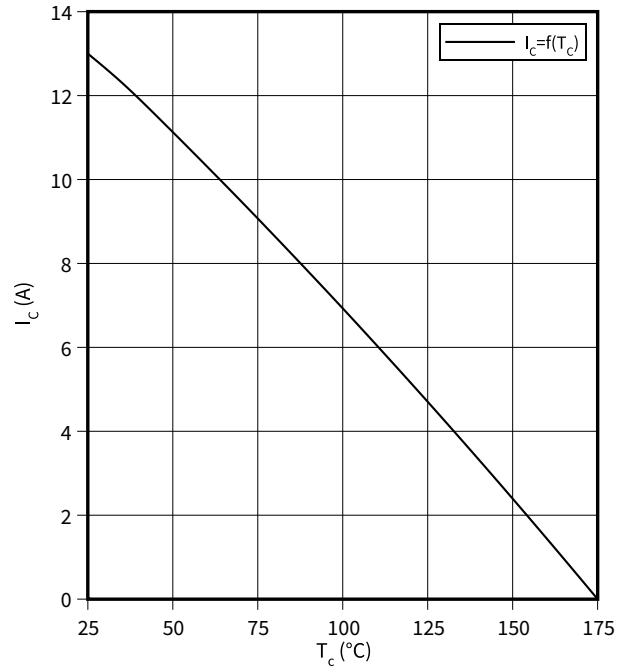
$D = 0$, $T_{vj} \geq 25\text{ °C}$, $V_{GE} \geq 15\text{ V}$, $T_h = 25\text{ °C}$



Collector current as a function of case temperature, IGBT

$$I_C = f(T_c)$$

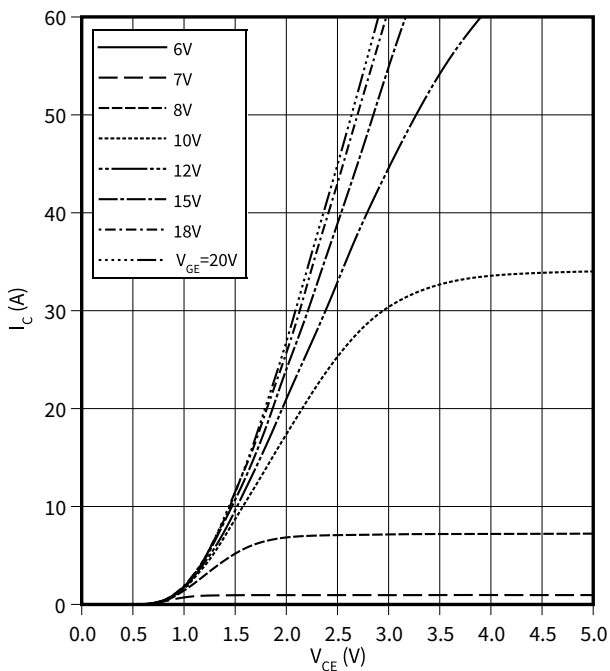
$T_{vj} \leq 175\text{ °C}$, $V_{GE} \geq 15\text{ V}$



Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

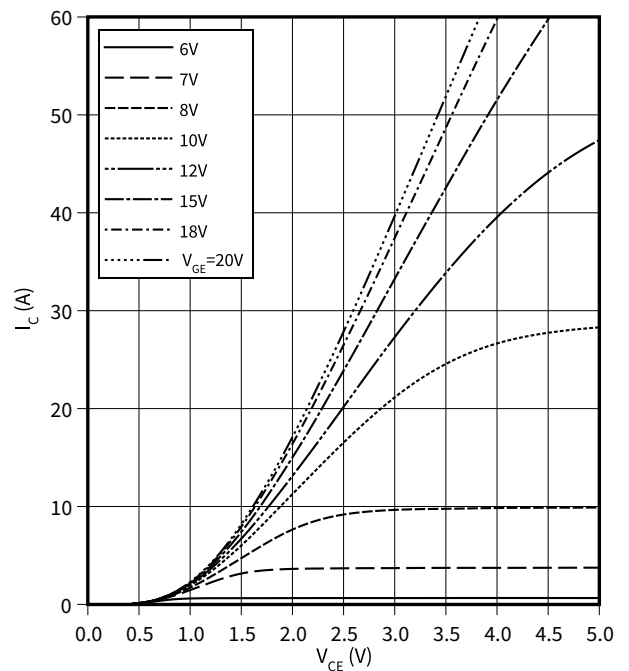
$T_{vj} = 25\text{ °C}$



Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

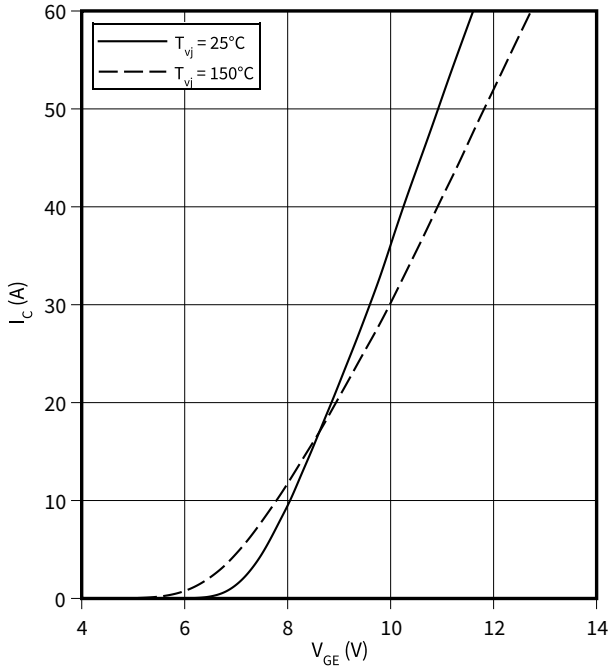
$T_{vj} = 150\text{ °C}$



4 Characteristics diagrams

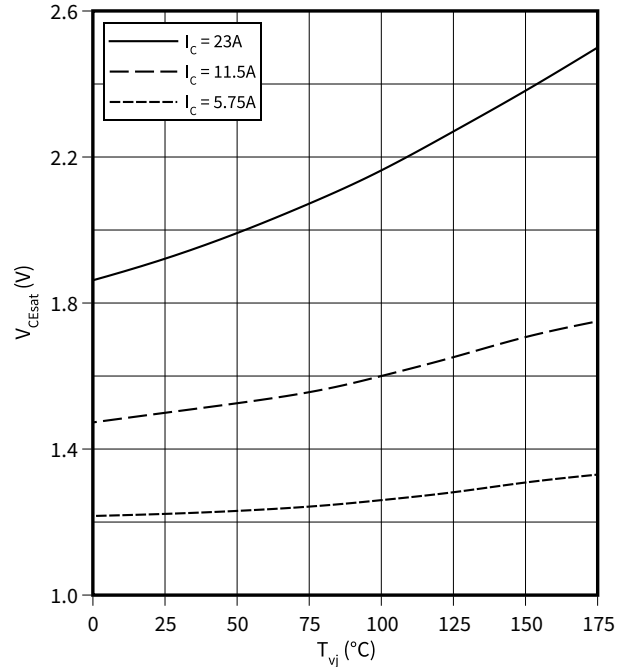
Typical transfer characteristic, IGBT

$I_C = f(V_{GE})$
 $V_{CE} = 50\text{ V}$



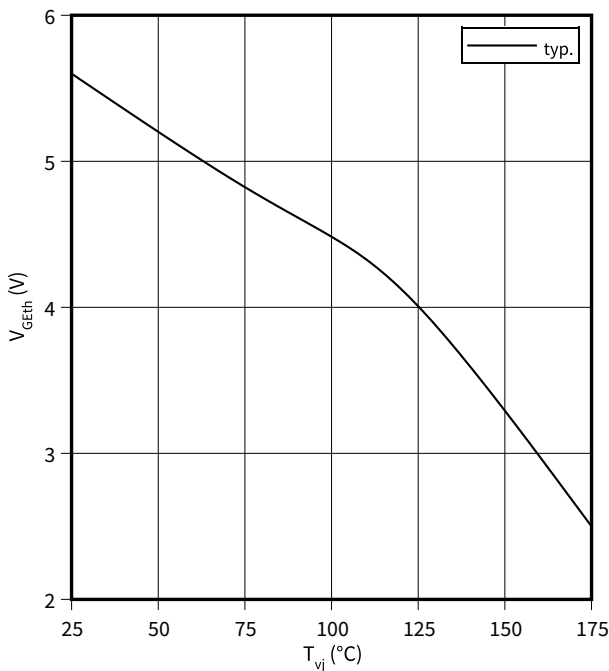
Typical collector-emitter saturation voltage as a function of junction temperature, IGBT

$V_{CEsat} = f(T_{vj})$
 $V_{GE} = 15\text{ V}$



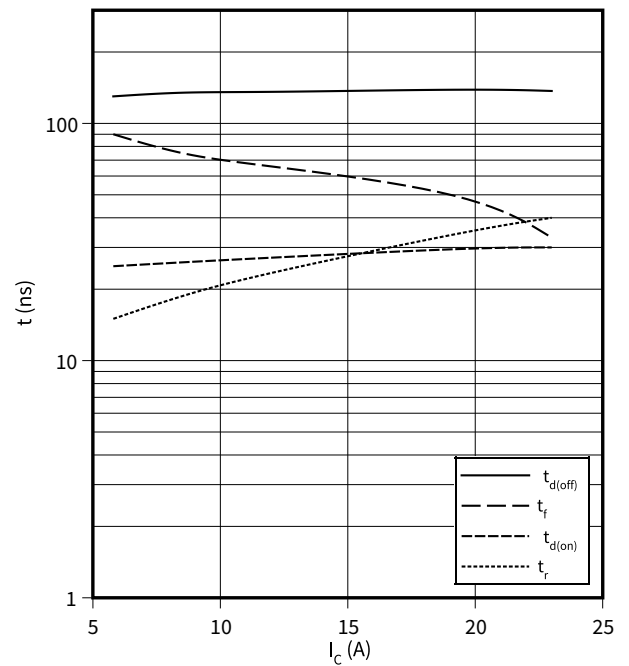
Gate-emitter threshold voltage as a function of junction temperature, IGBT

$V_{GEth} = f(T_{vj})$
 $I_C = 0.20\text{ mA}$



Typical switching times as a function of collector current, IGBT

$t = f(I_C)$
 $V_{CE} = 400\text{ V}, T_{vj} = 150^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 47\ \Omega$

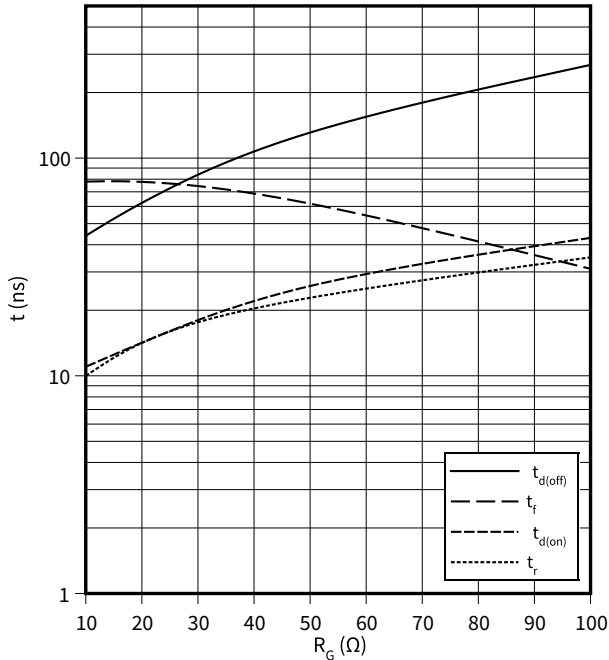


4 Characteristics diagrams

Typical switching times as a function of gate resistor, IGBT

$t = f(R_G)$

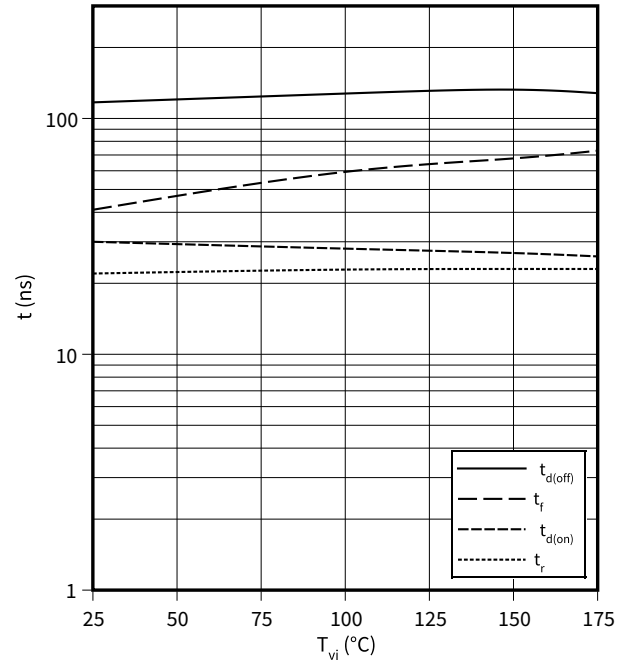
$I_C = 11.5 \text{ A}$, $V_{CE} = 400 \text{ V}$, $T_{vj} = 150 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching times as a function of junction temperature, IGBT

$t = f(T_{vj})$

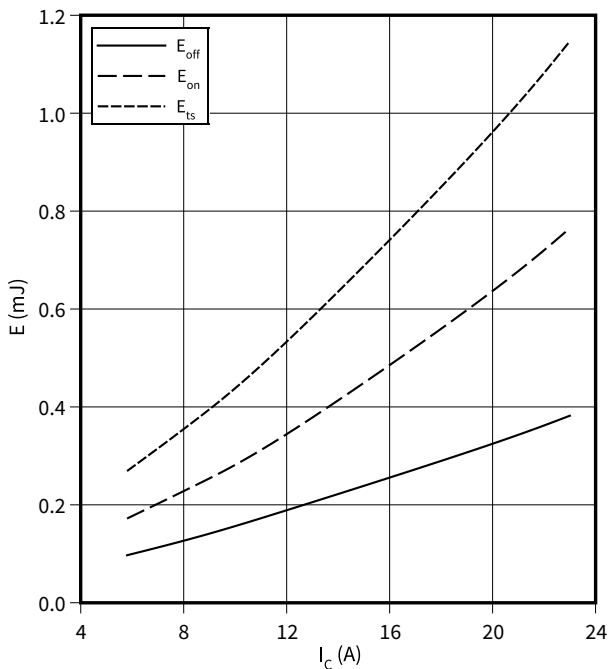
$I_C = 11.5 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 47 \text{ }\Omega$



Typical switching energy losses as a function of collector current, IGBT

$E = f(I_C)$

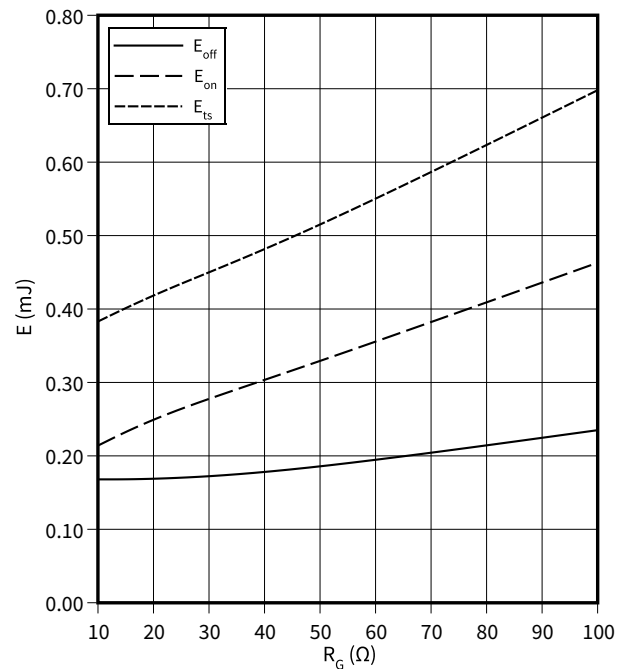
$V_{CE} = 400 \text{ V}$, $T_{vj} = 150 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 47 \text{ }\Omega$



Typical switching energy losses as a function of gate resistor, IGBT

$E = f(R_G)$

$I_C = 11.5 \text{ A}$, $V_{CE} = 400 \text{ V}$, $T_{vj} = 150 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$

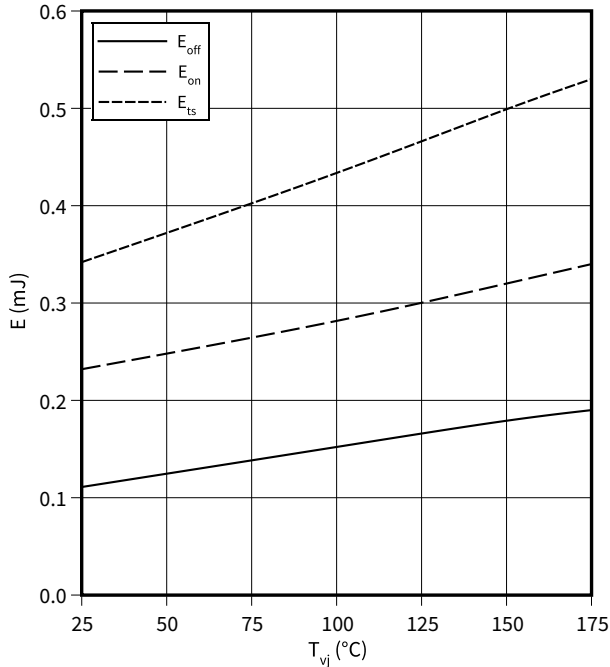


4 Characteristics diagrams

Typical switching energy losses as a function of junction temperature, IGBT

$E = f(T_{vj})$

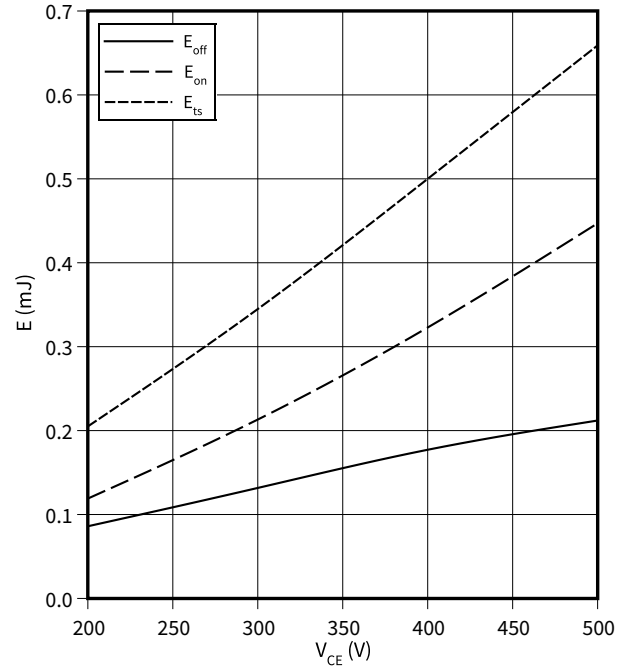
$I_C = 11.5 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 47 \Omega$



Typical switching energy losses as a function of collector emitter voltage, IGBT

$E = f(V_{CE})$

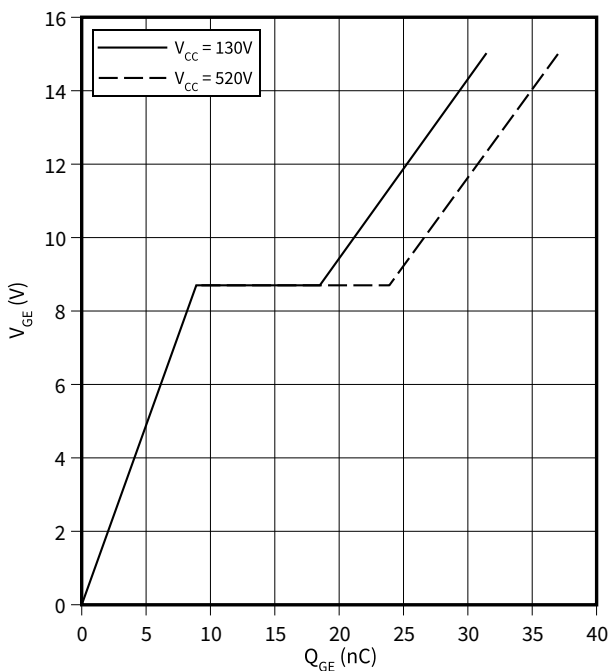
$I_C = 11.5 \text{ A}$, $V_{GE} = 0/15 \text{ V}$, $T_{vj} = 150 \text{ °C}$, $R_G = 47 \Omega$



Typical gate charge, IGBT

$V_{GE} = f(Q_{GE})$

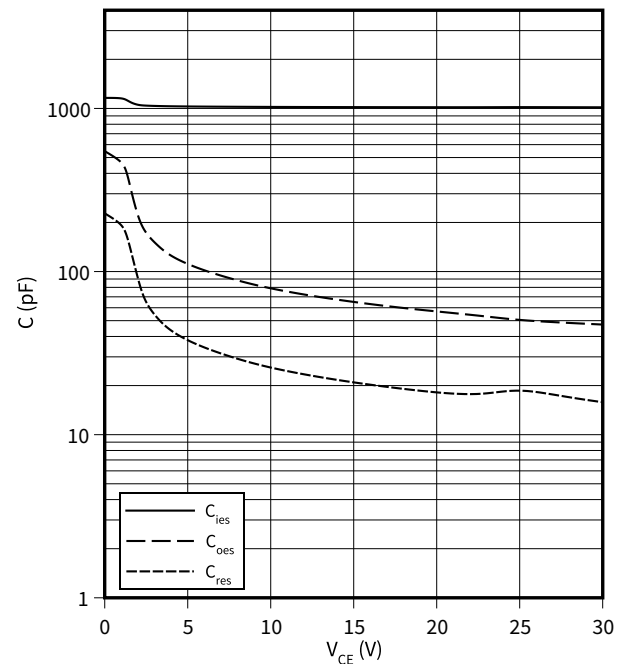
$I_C = 11.5 \text{ A}$



Typical capacitance as a function of collector-emitter voltage, IGBT

$C = f(V_{CE})$

$f = 1000 \text{ kHz}$, $V_{GE} = 0 \text{ V}$



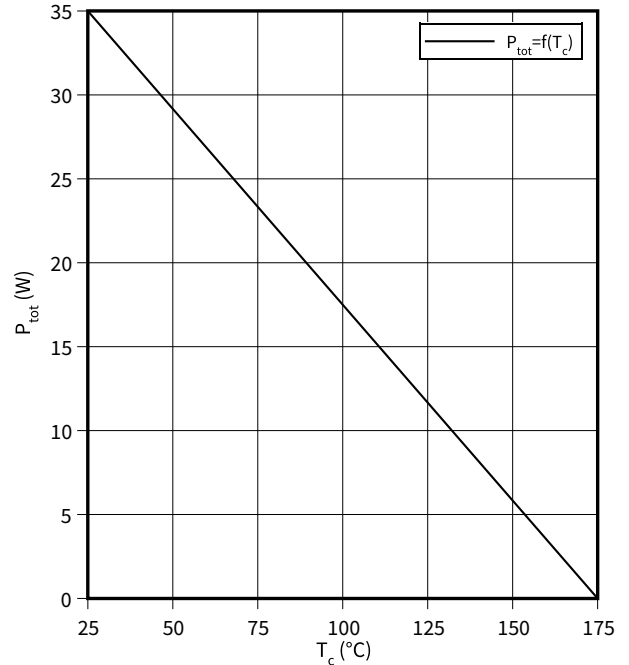
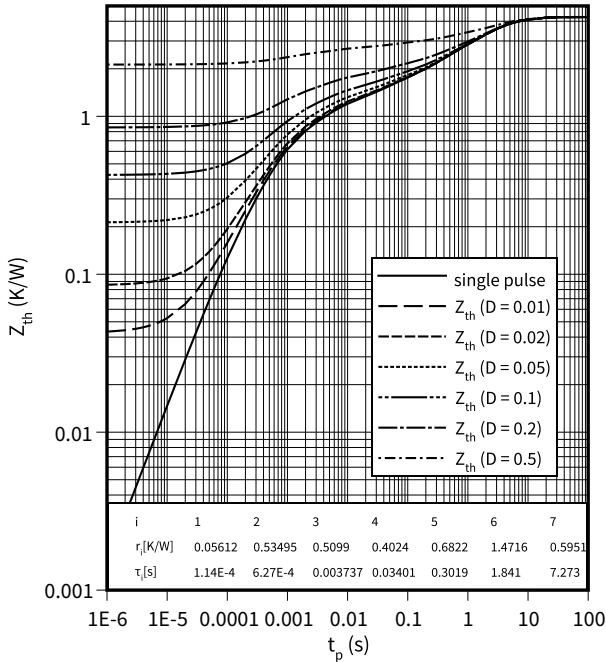
4 Characteristics diagrams

IGBT transient thermal impedance, IGBT

$Z_{th} = f(t_p)$
 $D = t_p/T$

Power dissipation as a function of case temperature, IGBT

$P_{tot} = f(T_c)$
 $T_{vj} \leq 175\text{ °C}$

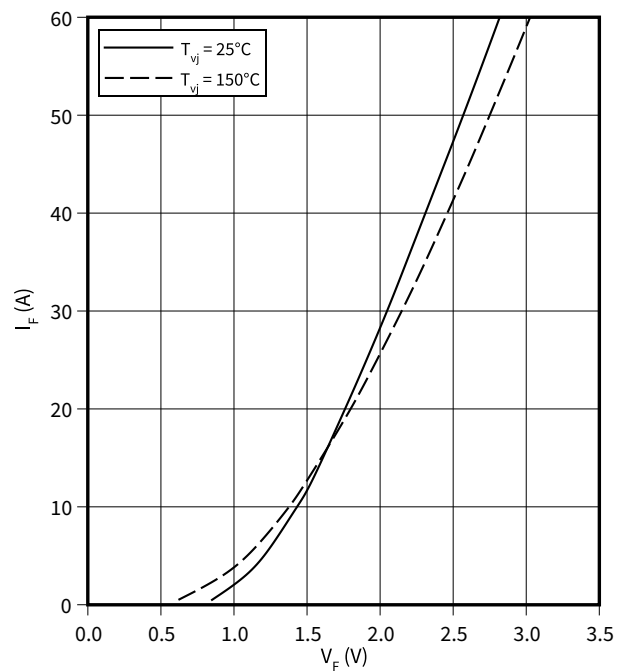
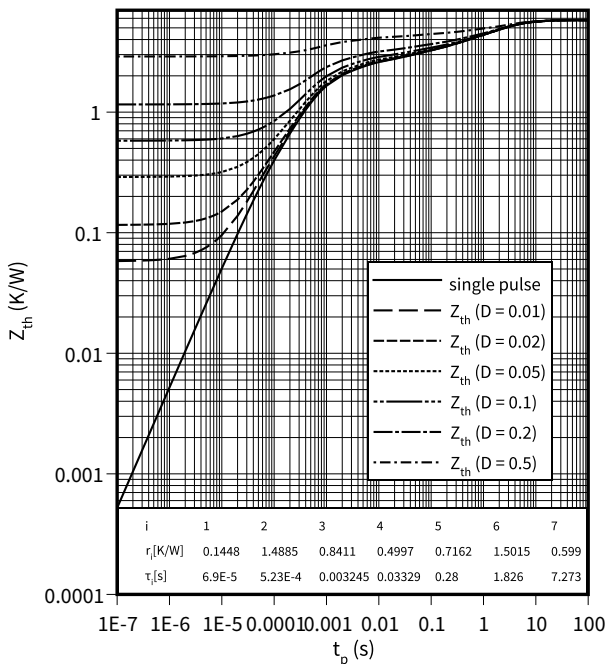


Diode transient thermal impedance as a function of pulse width, Diode

$Z_{th} = f(t_p)$
 $D = t_p/T$

Typical diode forward current as a function of forward voltage, Diode

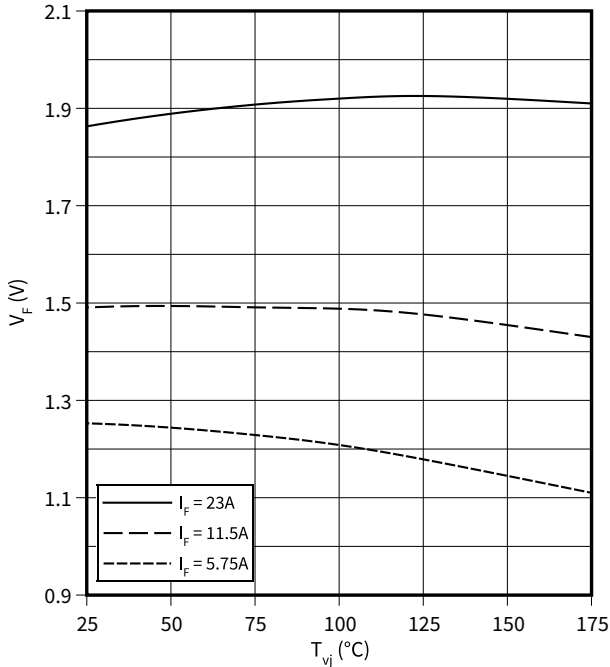
$I_F = f(V_F)$



4 Characteristics diagrams

Typical diode forward voltage as a function of junction temperature, Diode

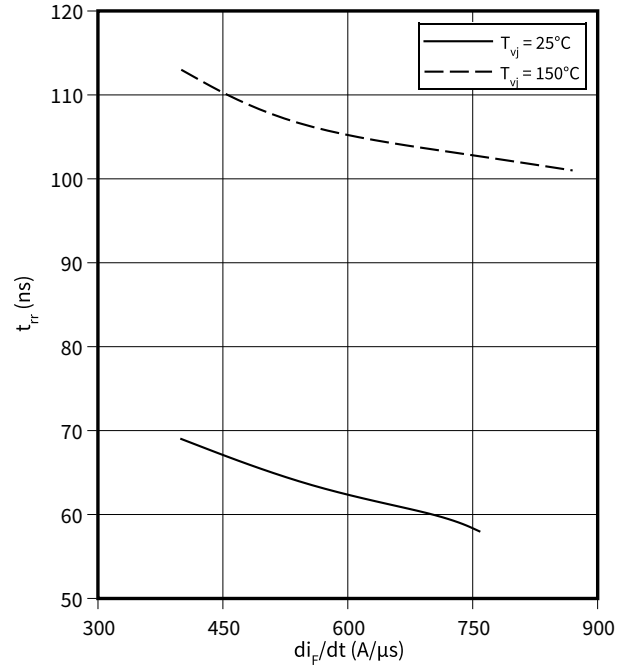
$V_F = f(T_{vj})$



Typical reverse recovery time as a function of diode current slope, Diode

$t_{rr} = f(di_F/dt)$

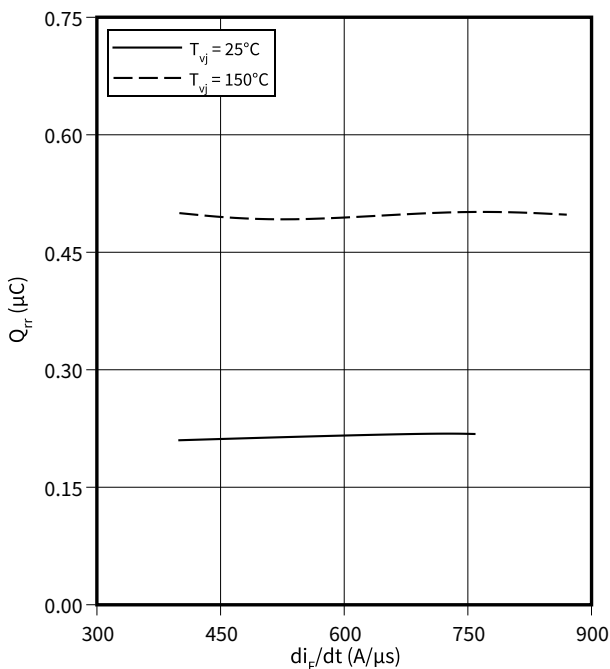
$V_R = 400 V, I_F = 11.5 A$



Typical reverse recovery charge as a function of diode current slope, Diode

$Q_{rr} = f(di_F/dt)$

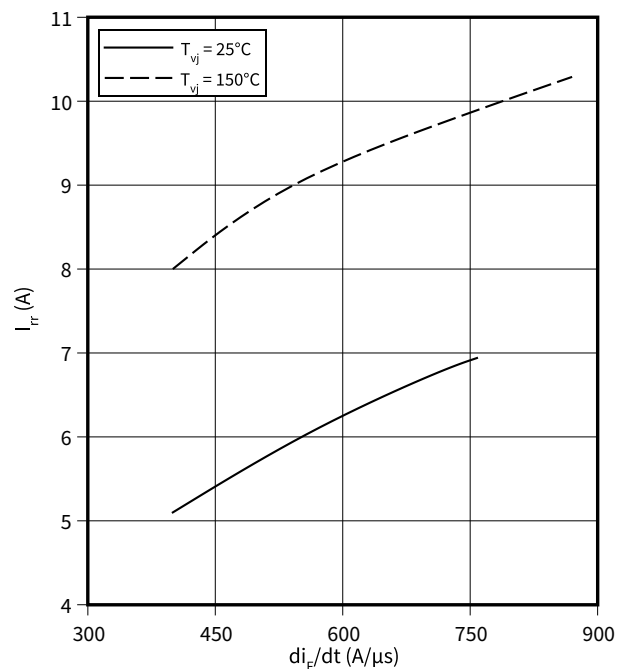
$V_R = 400 V, I_F = 11.5 A$



Typical reverse recovery current as a function of diode current slope, Diode

$I_{rr} = f(di_F/dt)$

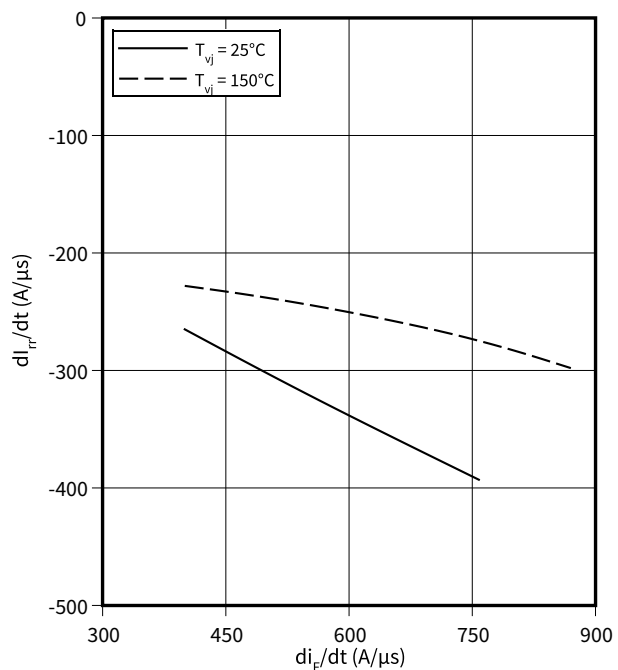
$V_R = 400 V, I_F = 11.5 A$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode

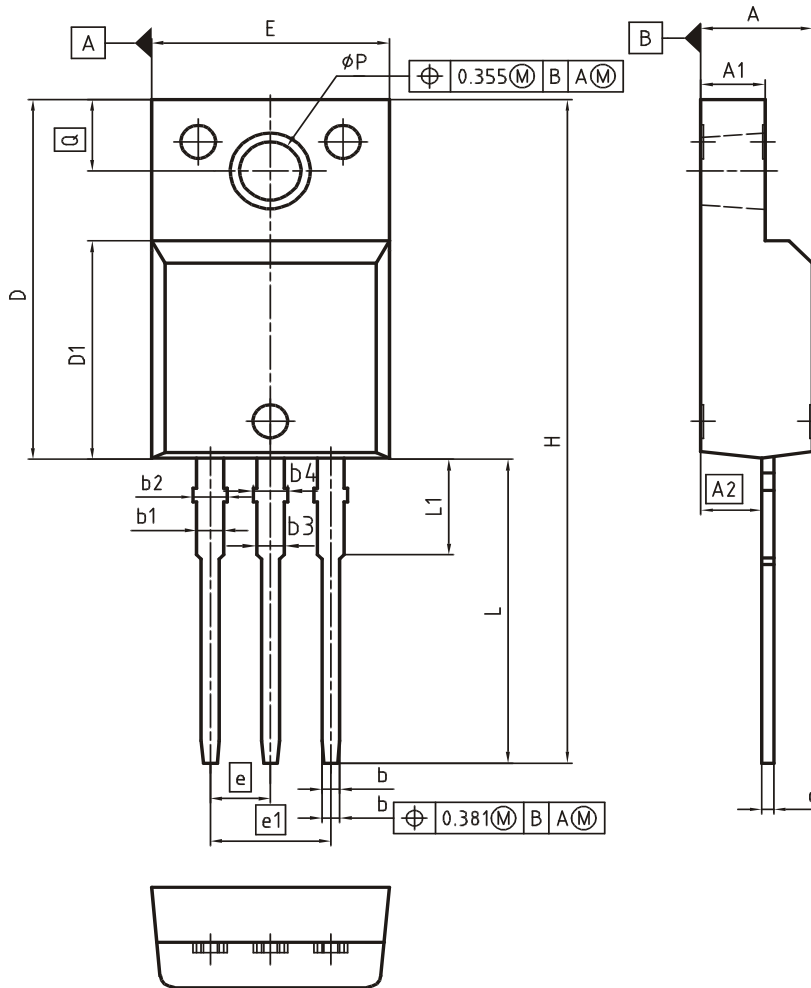
$$di_{rr}/dt = f(di_F/dt)$$

$V_R = 400\text{ V}$, $I_F = 11.5\text{ A}$



5 Package outlines

Package Drawing PG-TO220-3-FP



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.55 | 4.85 | 0.179 | 0.191 |
| A1 | 2.55 | 2.85 | 0.100 | 0.112 |
| A2 | 2.42 | 2.72 | 0.095 | 0.107 |
| b | 0.65 | 0.85 | 0.026 | 0.033 |
| b1 | 0.95 | 1.33 | 0.037 | 0.052 |
| b2 | 0.95 | 1.51 | 0.037 | 0.059 |
| b3 | 0.65 | 1.33 | 0.026 | 0.052 |
| b4 | 0.65 | 1.51 | 0.026 | 0.059 |
| c | 0.40 | 0.63 | 0.016 | 0.025 |
| D | 15.85 | 16.15 | 0.624 | 0.636 |
| D1 | 9.53 | 9.83 | 0.375 | 0.387 |
| E | 10.35 | 10.65 | 0.407 | 0.419 |
| e | 2.54 | | 0.100 | |
| e1 | 5.08 | | 0.200 | |
| N | 3 | | 3 | |
| H | 29.45 | 29.75 | 1.159 | 1.171 |
| L | 13.45 | 13.75 | 0.530 | 0.541 |
| L1 | 3.15 | 3.45 | 0.124 | 0.136 |
| øP | 2.95 | 3.20 | 0.116 | 0.126 |
| Q | 3.15 | 3.50 | 0.124 | 0.138 |

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Figure 1

6 Testing conditions

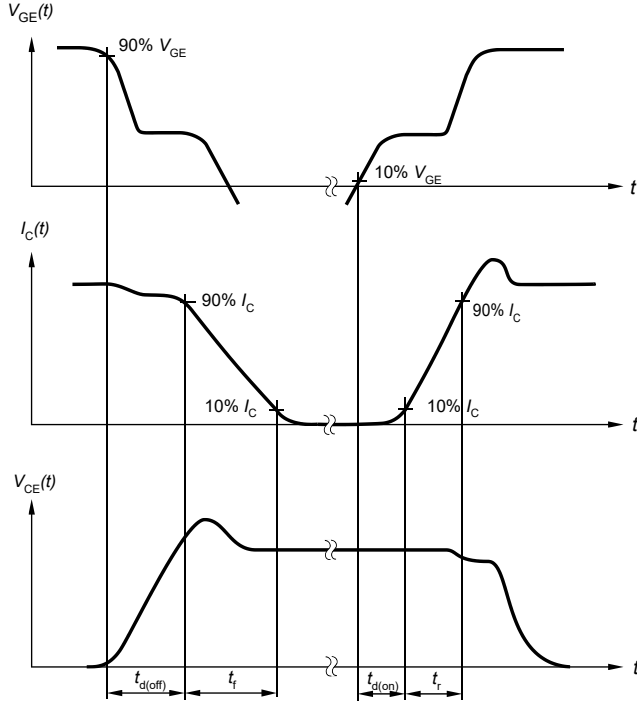


Figure A. Definition of switching times

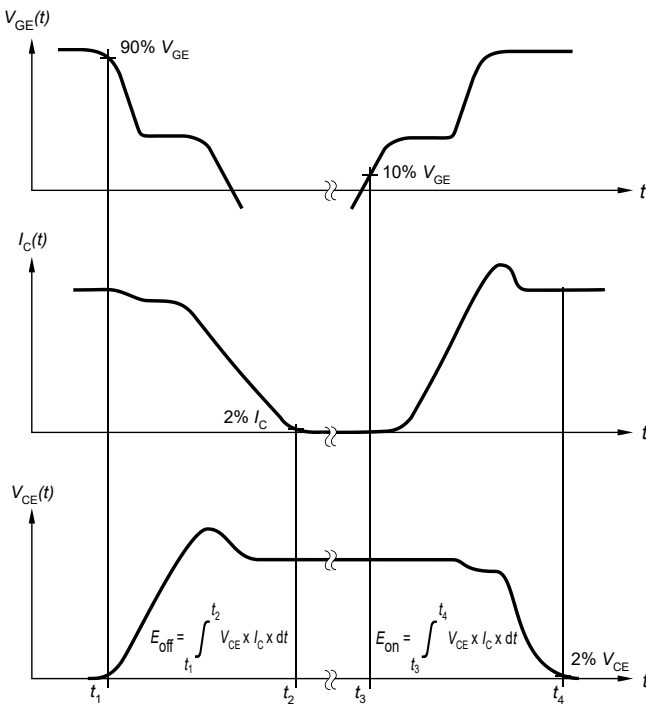


Figure B. Definition of switching losses

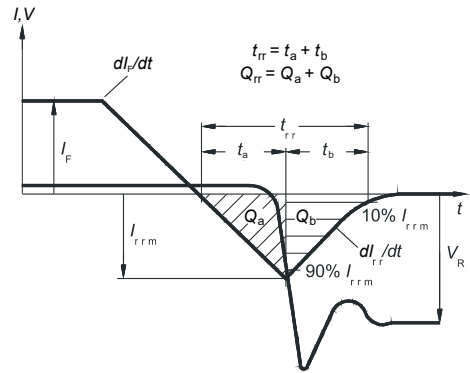


Figure C. Definition of diode switching characteristics

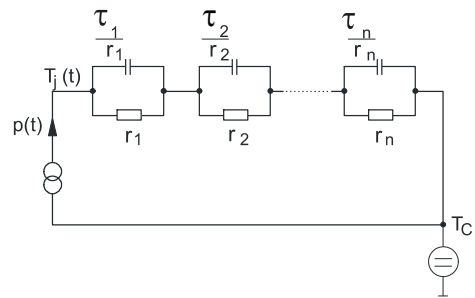


Figure D. Thermal equivalent circuit

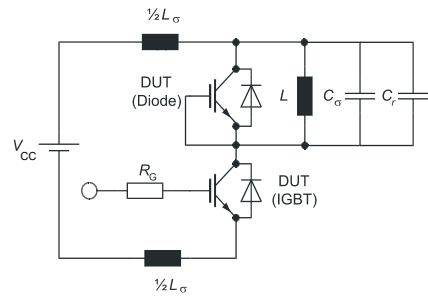


Figure E. Dynamic test circuit
Parasitic inductance L_{σ} ,
parasitic capacitor C_{σ} ,
relief capacitor C_r ,
(only for ZVT switching)

Figure 2

Revision history

| Document revision | Date of release | Description of changes |
|--------------------------|------------------------|---|
| V2.1 | 2017-09-11 | Final Datasheet |
| V2.2 | 2017-11-30 | New Gfs Value at VCE=20V |
| V2.3 | 2019-09-13 | Change of Rth/Zth values and maximum DC ratings |
| 1.10 | 2021-10-18 | Change of unit in thermal impedance figures |

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